



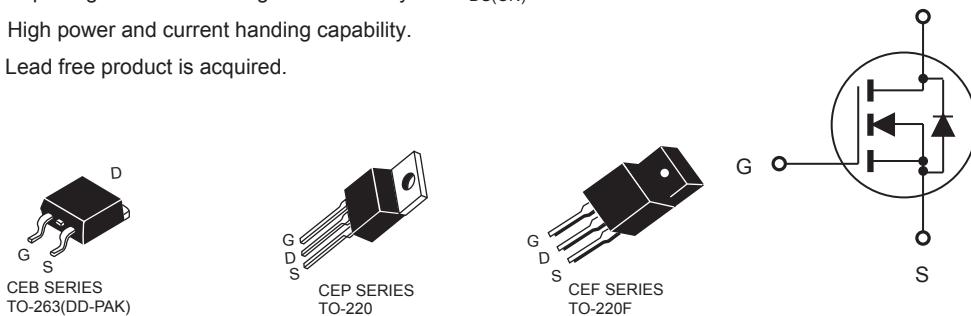
# CEP13N5/CEB13N5 CEF13N5

## N-Channel Enhancement Mode Field Effect Transistor

### FEATURES

Type	V <sub>DSS</sub>	R <sub>DS(ON)</sub>	I <sub>D</sub>	@V <sub>GS</sub>
CEP13N5	500V	0.48Ω	13A	10V
CEB13N5	500V	0.48Ω	13A	10V
CEF13N5	500V	0.48Ω	13A <sup>d</sup>	10V

- Super high dense cell design for extremely low R<sub>DS(ON)</sub>.
- High power and current handing capability.
- Lead free product is acquired.



### ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Limit		Units
		TO-220/263	TO-220F	
Drain-Source Voltage	V <sub>DS</sub>	500		V
Gate-Source Voltage	V <sub>GS</sub>	±30		V
Drain Current-Continuous @ $T_C = 25^\circ\text{C}$	I <sub>D</sub>	13	13 <sup>d</sup>	A
Drain Current-Continuous @ $T_C = 100^\circ\text{C}$	I <sub>D</sub>	8	8 <sup>d</sup>	A
Drain Current-Pulsed <sup>a</sup>	I <sub>DM</sub> <sup>e</sup>	52	52 <sup>d</sup>	A
Maximum Power Dissipation @ $T_C = 25^\circ\text{C}$ - Derate above 25°C	P <sub>D</sub>	214	60	W
		1.43	0.4	W/°C
Single Pulsed Avalanche Energy <sup>h</sup>	E <sub>AS</sub>	781		mJ
Single Pulsed Avalanche Current <sup>h</sup>	I <sub>AS</sub>	12.5		A
Operating and Store Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to 175		°C

### Thermal Characteristics

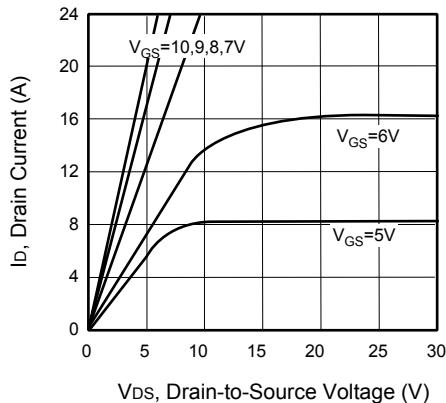
Parameter	Symbol	Limit		Units
Thermal Resistance, Junction-to-Case	R <sub>JC</sub>	0.7	2.5	°C/W
Thermal Resistance, Junction-to-Ambient	R <sub>JA</sub>	62.5	65	°C/W



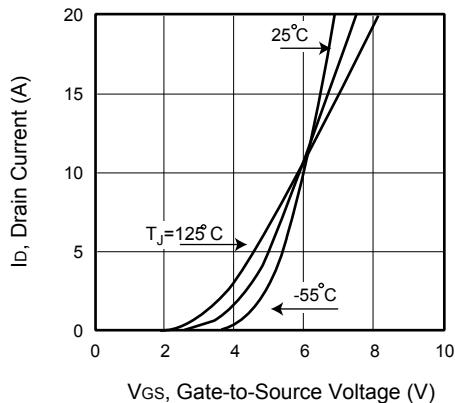
# CEP13N5/CEB13N5 CEF13N5

## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

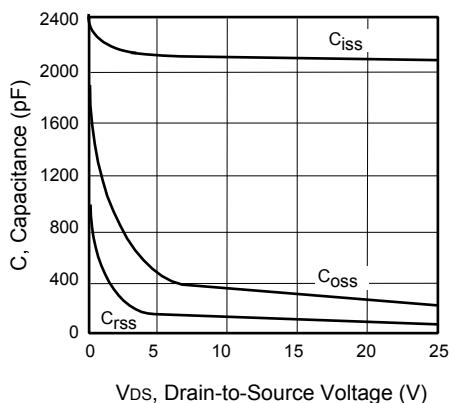
Parameter	Symbol	Test Condition	Min	Typ	Max	Units
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_{\text{D}} = 250\mu\text{A}$	500			V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 500\text{V}, V_{\text{GS}} = 0\text{V}$		1		$\mu\text{A}$
Gate Body Leakage Current, Forward	$I_{\text{GSSF}}$	$V_{\text{GS}} = 30\text{V}, V_{\text{DS}} = 0\text{V}$		100		nA
Gate Body Leakage Current, Reverse	$I_{\text{GSSR}}$	$V_{\text{GS}} = -30\text{V}, V_{\text{DS}} = 0\text{V}$		-100		nA
<b>On Characteristics<sup>b</sup></b>						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{GS}} = V_{\text{DS}}, I_{\text{D}} = 250\mu\text{A}$	2		4	V
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_{\text{D}} = 6.5\text{A}$		0.38	0.48	$\Omega$
Forward Transconductance	$g_{\text{FS}}$	$V_{\text{DS}} = 25\text{V}, I_{\text{D}} = 6.5\text{A}$		10		S
<b>Dynamic Characteristics<sup>c</sup></b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}} = 25\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0 \text{ MHz}$		2100		pF
Output Capacitance	$C_{\text{oss}}$			220		pF
Reverse Transfer Capacitance	$C_{\text{rss}}$			7		pF
<b>Switching Characteristics<sup>c</sup></b>						
Turn-On Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 250\text{V}, I_{\text{D}} = 13\text{A}, V_{\text{GS}} = 10\text{V}, R_{\text{GEN}} = 25\Omega$		42	84	ns
Turn-On Rise Time	$t_r$			62	124	ns
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$			130	260	ns
Turn-Off Fall Time	$t_f$			25	50	ns
Total Gate Charge	$Q_g$	$V_{\text{DS}} = 400\text{V}, I_{\text{D}} = 13\text{A}, V_{\text{GS}} = 10\text{V}$		50	66	nC
Gate-Source Charge	$Q_{\text{gs}}$			11		nC
Gate-Drain Charge	$Q_{\text{gd}}$			19		nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Drain-Source Diode Forward Current	$I_s^f$				13	A
Drain-Source Diode Forward Voltage <sup>b</sup>	$V_{\text{SD}}^g$	$V_{\text{GS}} = 0\text{V}, I_s = 13\text{A}$			1.4	V
<b>Notes :</b>						
a.Repetitive Rating : Pulse width limited by maximum junction temperature .						
b.Pulse Test : Pulse Width $\leq 300\mu\text{s}$ , Duty Cycle $\leq 2\%$ . c.Guaranteed by design, not subject to production testing. d.Limited only by maximum temperature allowed . e.Pulse width limited by safe operating area . f.Full package $I_s(\text{max}) = 6.6\text{A}$ . g.Full package $V_{\text{SD}}$ test condition $I_s = 6.6\text{A}$ . h.Vdd=50V L=10mH Is=12.5A						



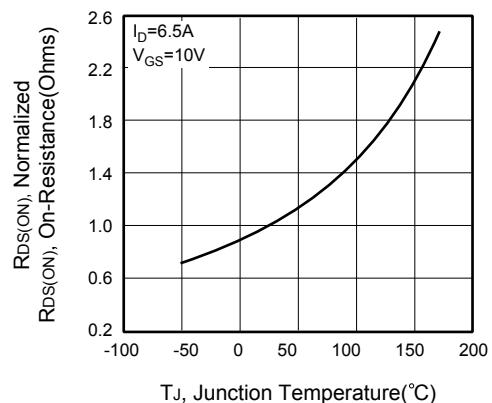
**Figure 1. Output Characteristics**



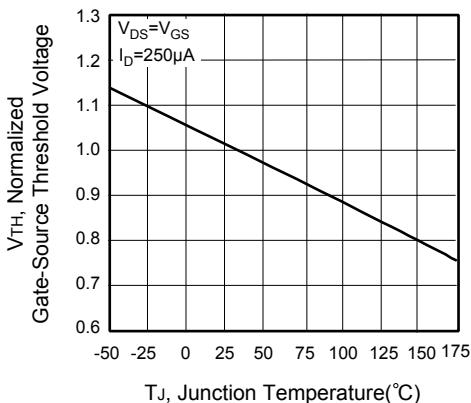
**Figure 2. Transfer Characteristics**



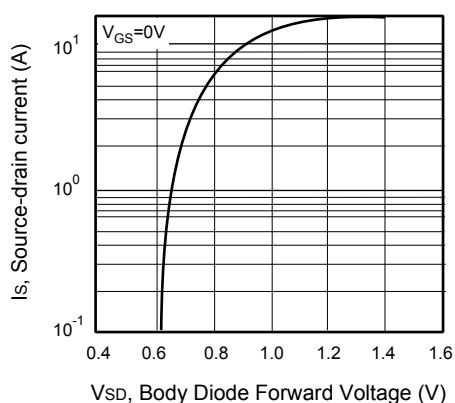
**Figure 3. Capacitance**



**Figure 4. On-Resistance Variation with Temperature**



**Figure 5. Gate Threshold Variation with Temperature**



**Figure 6. Body Diode Forward Voltage Variation with Source Current**

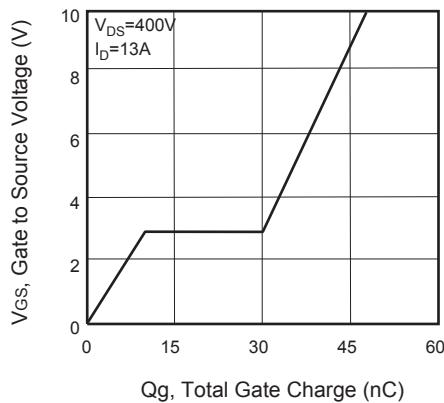


Figure 7. Gate Charge

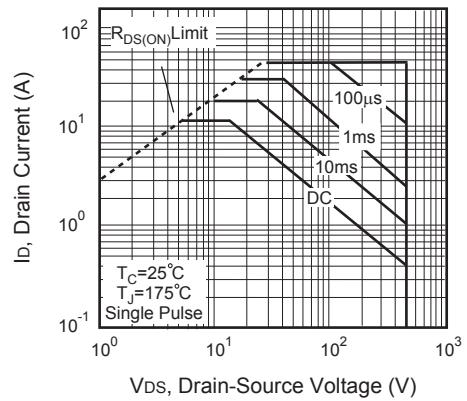


Figure 8. Maximum Safe Operating Area



Figure 9. Switching Test Circuit



Figure 10. Switching Waveforms

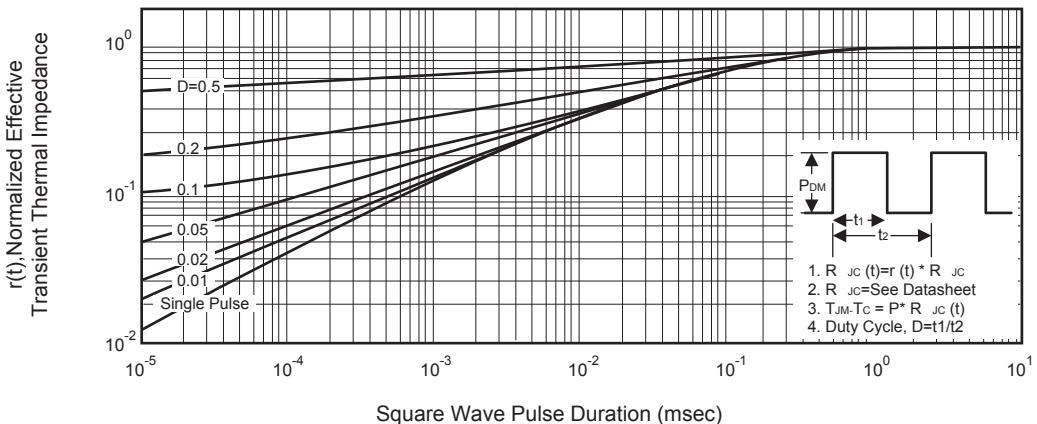


Figure 11. Normalized Thermal Transient Impedance Curve